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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. .... 10/734,072  
Reissue of ..... U.S. Patent No. 6,329,213  
Confirmation No. .... 8908  
Filing Date ..... December 10, 2003  
Inventor ..... Mark E. Tuttle et al.  
Assignee ..... Micron Technology, Inc.  
Group Art Unit ..... 2891  
Examiner ..... Caridad Everhart  
Customer No. .... 021567  
Attorney Docket No. .... M140-369  
Title: Methods for Forming Integrated Circuits Within Substrates

**RESPONSE TO NOVEMBER 15, 2006 FINAL OFFICE ACTION**  
**UNDER 37 CFR §1.173**

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**AMENDMENTS**

Responsive to the Final Office Action dated November 15, 2006 in this Reissue application, Applicants amend and remark as follows. Unless otherwise indicated, deletions are [bracketed], additions are underlined to indicate changes relative to the patent.